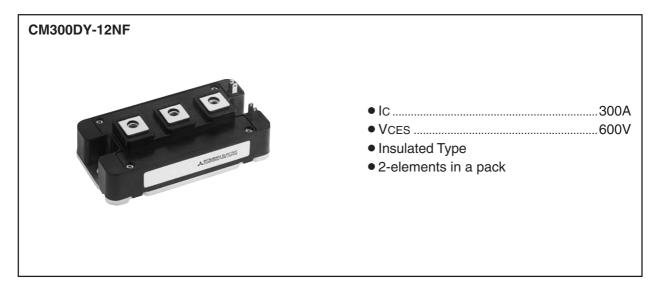
MITSUBISHI IGBT MODULES

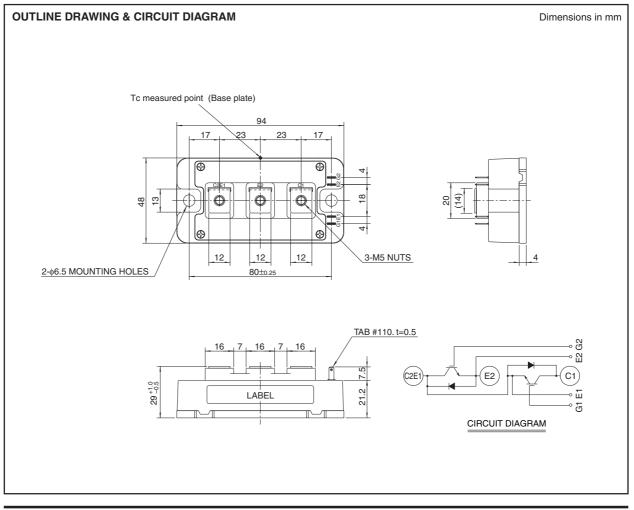
CM300DY-12NF

HIGH POWER SWITCHING USE



APPLICATION

General purpose inverters & Servo controls, etc





CM300DY-12NF

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MAXIMUM RATINGS (Tj = 25°C, unless otherwise specified)

| Symbol | Parameter | Conditions | | Ratings | Unit |
|--------------|-------------------------------|---|----------|------------|-------|
| VCES | Collector-emitter voltage | G-E Short | | 600 | V |
| VGES | Gate-emitter voltage | C-E Short | | ±20 | V |
| IC | Collector current | DC, Tc' = $89^{\circ}C^{*3}$ | | 300 | A |
| Ісм | Collector current | Pulse | (Note 2) | 600 | A |
| IE (Note 1) | Emitter current | | | 300 | A |
| IEM (Note 1) | Emiller current | Pulse | (Note 2) | 600 | A |
| PC (Note 3) | Maximum collector dissipation | $TC = 25^{\circ}C$ | | 780 | W |
| Tj | Junction temperature | | | -40 ~ +150 | °C |
| Tstg | Storage temperature | | | -40 ~ +125 | °C |
| Viso | Isolation voltage | Terminals to base plate, f = 60Hz, AC 1 min | ute | 2500 | Vrms |
| _ | Taxay a strangeth | Main terminals M5 screw | | 2.5 ~ 3.5 | N • m |
| _ | Torque strength | Mounting M6 screw | | 3.5 ~ 4.5 | N • m |
| _ | Weight | Typical value | | 310 | g |

ELECTRICAL CHARACTERISTICS (Tj = 25°C, unless otherwise specified)

| 0 | Parameter | Test conditions | | Limits | | | 1.1 |
|--------------|--------------------------------------|---|------------|--------|------|---------------------|------|
| Symbol | Parameter | | | Min. | Тур. | Max. | Unit |
| ICES | Collector cutoff current | VCE = VCES, VGE = 0V | | | | 1 | mA |
| VGE(th) | Gate-emitter threshold voltage | IC = 30mA, VCE = 10V | | 5 | 6 | 7.5 | v |
| IGES | Gate leakage current | $\pm V$ GE = VGES, VCE = 0V | | _ | _ | 0.5 | μA |
| VCE(sat) | Collector-emitter saturation voltage | | Tj = 25°C | _ | 1.7 | 2.2 | V |
| | | IC = 300A, VGE = 15V | Tj = 125°C | _ | 1.7 | _ | |
| Cies | Input capacitance | VCE = 10V VGE = 0V | | | _ | 45 | nF |
| Coes | Output capacitance | | | _ | _ | 5.5 | nF |
| Cres | Reverse transfer capacitance | | | _ | _ | 1.8 | nF |
| QG | Total gate charge | VCC = 300V, IC = 300A, VGE = 15V | | _ | 1200 | _ | nC |
| td(on) | Turn-on delay time | Vcc = 300V, lc = 300A VGE = $\pm 15V$ RG = 2.1 Ω , Inductive load IE = 300A | | _ | — | 120 | ns |
| tr | Turn-on rise time | | | _ | _ | 120 | ns |
| td(off) | Turn-off delay time | | | _ | — | 350 | ns |
| tf | Turn-off fall time | | | _ | _ | 300 | ns |
| trr (Note 1) | Reverse recovery time | | | _ | _ | 150 | ns |
| Qrr (Note 1) | Reverse recovery charge | | | _ | 5.5 | — | μC |
| VEC(Note 1) | Emitter-collector voltage | IE = 300A, VGE = 0V | | _ | _ | 2.6 | V |
| Rth(j-c)Q | *1 | IGBT part (1/2 module) | | _ | _ | 0.16 | K/W |
| Rth(j-c)R | Thermal resistance ^{*1} | FWDi part (1/2 module) | | _ | _ | 0.25 | K/W |
| Rth(c-f) | Contact thermal resistance | Case to heat sink, Thermal compound Applied ^{*2} (1/2 module) | | _ | 0.07 | — | K/W |
| Rth(j-c')Q | Thermal resistance | Case temperature measured point is just under the chips | | _ | — | 0.093 ^{*3} | K/W |
| RG | External gate resistance | | | 2.1 | — | 21 | Ω |

*1 : Case temperature (Tc) measured point is shown in page OUTLINE DRAWING.
*2 : Typical value is measured by using thermally conductive grease of λ = 0.9[W/(m • K)].
*3 : Case temperature (Tc') measured point is just under the chips.

If you use this value, Rth(f-a) should be measured just under the chips.

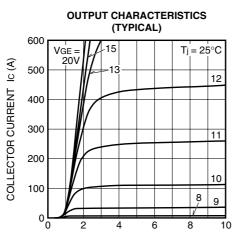
Note 1. IE, VEC, tr & Qrr represent characteristics of the anti-parallel, emitter-collector free-wheel diode (FWDi).
2. Pulse width and repetition rate should be such that the device junction temperature (Tj) does not exceed Tjmax rating.
3. Junction temperature (Tj) should not increase beyond 150°C.



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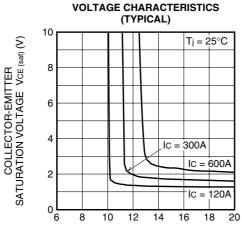
HIGH POWER SWITCHING USE



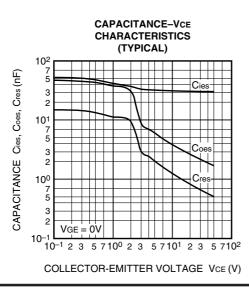


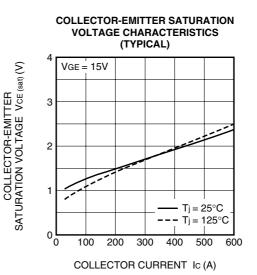
COLLECTOR-EMITTER VOLTAGE VCE (V)

COLLECTOR-EMITTER SATURATION

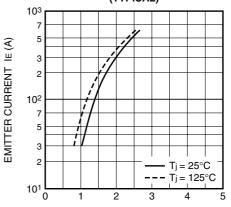


GATE-EMITTER VOLTAGE VGE (V)

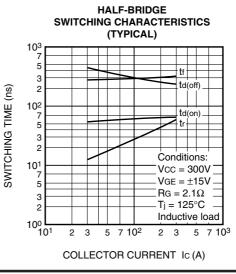




FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)

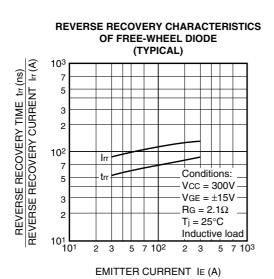


EMITTER-COLLECTOR VOLTAGE VEC (V)

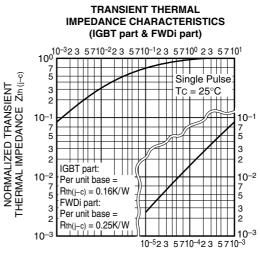


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GATE CHARGE CHARACTERISTICS (TYPICAL) 20 IC = 300Å GATE-EMITTER VOLTAGE VGE (V) 16 Vcc = 200V12 Vcc = 300V8 4 0 600 800 1200 1600 1000 1400 400 200 GATE CHARGE QG (nC)



TIME (s)



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